## SN54LS11, SN54S11, SN74LS11, SN74S11 TRIPLE 3-INPUT POSITIVE-AND GATES

APRIL 1985-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

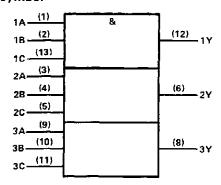
These devices contain three independent 3-input AND gates.

The SN54LS11 and SN54S11 are characterized for operation over the full military temperature range of  $-55\,^{\circ}\text{C}$  to 125  $^{\circ}\text{C}$ . The SN74LS11 and SN74S11 are characterized for operation from 0  $^{\circ}\text{C}$  to 70  $^{\circ}\text{C}$ .

#### **FUNCTION TABLE (each gate)**

	NPUT	s_	OUTPUT
Α	В	С	Υ
Н	н	н	н
L	Х	x	L
х	L	x	L
x	X	L	L

## logic symbol<sup>†</sup>



<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

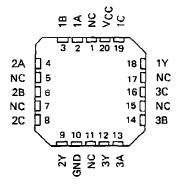
Pin numbers shown are for D, J, N, and W packages.

SN54LS11, SN74S11...J OR W PACKAGE SN74LS11, SN74S11 . . . D OR N PACKAGE (TOP VIEW) 1A □1 J14口 Vcc 1**B** 13 1C 12 1Y **□**3 2A 11 3C 28 □4 2C 3B □5 10 3A 2Y □6 **\_**[e

·SN54LS11, SN54S11 . . . FK PACKAGE (TOP VIEW)

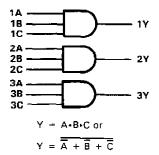
8 3Y

GND

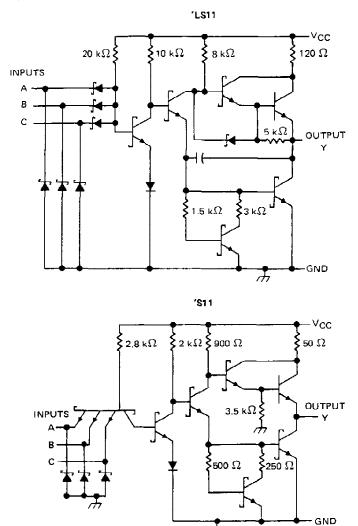


NC-No internal connection

#### logic diagram (positive logic)



#### schematics (each gate)



Resistor values shown are nominal.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)			 	 				7 V
Input voltage: 'S11			 	 	, ,			5.5 V
'LS11			 	 				7 V
Operating free-air temperature range:	SN54		 	 		5	5°C to 12	25°C
	SN74	<b></b>	 	 			0°C to 7	70°C
Storage temperature range			 	 		6	5°C to 15	50°C

NOTE 1: Voltage values are with respect to network ground terminal.



#### recommended operating conditions

		:	\$N54L\$11				SN74LS11			
		MIN	NOM	MAX	MIN	NOM	мах	UNIT		
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	ν		
v <sub>iH</sub>	High-level input voltage	2			2			V		
VIL	Low-level input voltage			0.7			8.0	٧		
lон	High-level output current			<b>- 0.4</b>			- 0.4	mA		
lor	Low-level output current			4			8	mA		
TA	Operating free-air temperature	- 55		125	0		70	°c		

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS †				SN54LS	11	S	1		
PARAMETER		IESI CONDI	TIONS T	MIN	TYP‡	MAX	MIN	TYP ‡	MAX	UNIT
V <sub>IK</sub>	VCC = MIN,	lj = — 18 mA	<u>-</u>			- 1.5			- 1.5	٧
voн	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OH</sub> = - 0.4 mA	2.5	3.4		2.7	3.4		٧
	VCC - MIN,	VIL = MAX,	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	V
VOL	VCC = MIN,	V <sub>IL</sub> = MAX,	I <sub>OL</sub> = 8 mA					0.35	0.4 0.5 0.1 20	V
11	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V	-			0.1			0.1	mΑ
Iн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				. 20			20	μД
ΊL	V <sub>CC</sub> = MAX,	V; = 0.4 V				0.4			- 0.4	mA
los §	V <sub>CC</sub> = MAX			- 20		100	- 20		- 100	mΑ
<sup>1</sup> ссн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 4.5 V			1.8	3.6		1.8	3.6	mΑ
'CCL	V <sub>CC</sub> = MAX,	v  = 0 v			3.3	6.6		3.3	6.6	mA

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CO	MIN	ТУР	мах	UNIT	
ФLН	A, B or C	<b>&gt;</b>	R <sub>1</sub> = 2 kΩ,	C <sub>1</sub> = 15 pF		8	15	ns
<sup>†</sup> PH L	A, B or C			C[ - 15 pr		10	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

# SN54S11, SN74S11 TRIPLE 3-INPUT POSITIVE-AND GATES

### recommended operating conditions

			SN54S11			SN74S11			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Уcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
Vін	High-level input voltage	2			2			V	
VIL	Low-level input voltage			0.8		•	0.8	٧	
ЮН	High-level output current			- 1			- 1	mΑ	
loL	Low-level output current			20			20	mΑ	
ΤA	Operating free-air temperature	- 55		125	0		70	°c	

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

BARAMETER	TEST CONDITIONS †					1				
PARAMETER		ST CONDITT	DIA9 1	MIN	TYP ‡	MAX	MIN	TYP ‡	MAX	UNIT
V <sub>IK</sub>	VCC = MIN, I	= — 18 mA	-			- 1.2			- 1.2	٧
∨он	VCC = MIN, VI	IH = 2 V,	I <sub>OH</sub> = − 1 mA	2.5	3.4		2.7	3.4		٧
V <sub>OL</sub>	VCC = MIN, V	<sub>IL</sub> = 0.8 ∨,	I <sub>OL</sub> = 20 mA			0.5			0.5	V
t <sub>l</sub>	VCC = MAX, VI	= 5.5 V				1			1	mA
ЧН	V <sub>CC</sub> = MAX, V <sub>I</sub>	= 2.7 V				50			50	μΑ
l <sub>IL</sub>	V <sub>CC</sub> = MAX, V <sub>t</sub>	= 0.5 V				<b>– 2</b>			- 2	mΑ
I <sub>OS</sub> §	V <sub>CC</sub> = MAX			-40		- 100	<b>- 4</b> 0		- 100	mA
Іссн	VCC = MAX, VI	- 4.5 ∨			13,5	24		13.5	24	mΑ
CCL	VCC = MAX, VI	= 0 V			24	42		24	42	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	IDITIONS	MiN	TYP	мах	UNIT
<sup>t</sup> PLH	A, B or C	_	R <sub>L</sub> = 280 Ω,	$R_1 = 280 \Omega$ , $C_1 = 15 pF$		4.5	7	ns
tpHL		\ <sub>\</sub>	116 200 101	C[ - 19 br		5	7.5	ns
†PLH		. [	D 200 o	2 - 52 - 5		6		गऽ
tpHL			R <sub>L</sub> = 280 Ω,	C <sub>L</sub> = 50 pF		7.5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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